

3mm Round With Flange Type Phototransistor Technical Data Sheet

Part No.: 304PTC4B-1AD



Features:

Popular T-1 diameter package. High efficiency. Selected minimum intensities. Available on tape and reel. Reliable and robust. The product itself will remain within RoHS compliant Version.

Descriptions:

The 304PT is a high speed and high sensitive silicon NPN phototransistor in a standard T-1 (Φ 3mm) clear epoxy package.

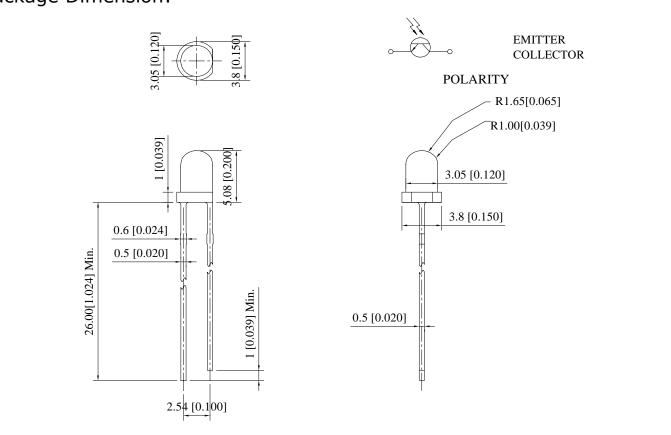
Due to its clear epoxy, the device is matched to visible light and infrared radiation.

Applications:

Infrared applied system. Counters and sorters. Encoders. Floppy disk drive. Optoelectronic switch. Video camera, tape and card readers. Position sensors.



Package Dimension:



Part No.	Chip Material	Lens Color	Source Color
304PTC4B-1AD	Silicon	Water Clear	Phototransistor

Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is \pm 0.25 mm (.010") unless otherwise noted.
- 3. Protruded resin under flange is 1.00 mm (.039") max.
- 4. Specifications are subject to change without notice.



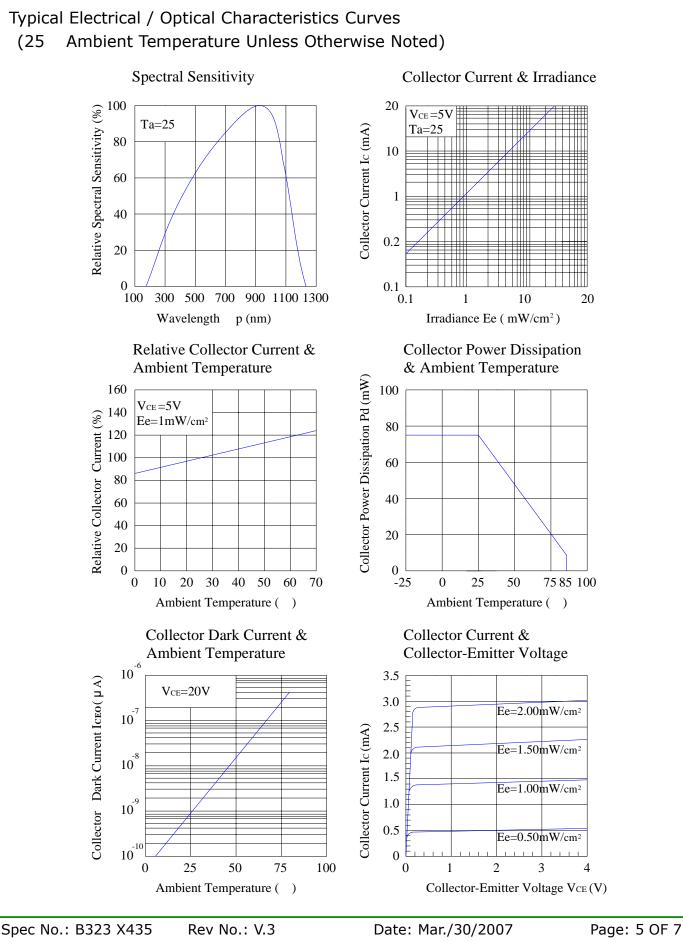
Absolute Maximum Ratings (Ta=25)

Parameters	Symbol	Rating	Unit
Power Dissipation at (or below) 25 free Air Temperature	P _D	75	mW
Collector-Emitter Voltage	V _{CEO}	30	V
Emitter-Collector-Voltage	V _{ECO}	5	V
Collector Current	I _C	20	mA
Operating Temperature	Topr	-40 to +85	
Storage Temperature	Tstg	-40 to +100	
Lead Soldering Temperature [4mm (.157") From Body]	Tsol	260 for 5 Seconds	

Electrical Optical Characteristics at Ta=25

Parameters	Symbol	Min.	Тур.	Max.	Unit	Condition
Collector-Emitter Breakdown Voltage	BV _{CEO}	30			V	I_{C} =100µA, Ee=0mW/cm ²
Emitter-Collector Breakdown Voltage	BV _{ECO}	5			V	Ie=100µA, Ee=0mW/cm ²
Collector-Emitter Saturation Voltage	V _{CE(SAT)}			0.40	V I _c =0.70mA, Ee=1mW/cm	
Optical Rise Time (10% to 90%)	T _R		15		ns	$V_{CE}=5V$,
Optical Fall Time (90% to 10%)	T _F		15		115	$I_{C}=1mA$, R _L =1000 Ω
Collector Dark Current	\mathbf{I}_{CEO}			100	nA	$\begin{array}{c} \text{Ee=0mW/cm^{2},}\\ \text{V}_{\text{CE}}\text{=20V} \end{array}$
On State Collector Current	I _{C(ON)}	0.50	2.00		mA	Ee=1mW/cm ² , V _{CE} =5V
Reception Angle	20 _{1/2}		20		Deg	
Wavelength Of Peak Sensitivity	λP		940		nm	
Rang Of Spectral Bandwidth	λ0.5	400		1100	nm	





Spec No.: B323 X435Rev No.: V.3Approved: JoJoChecked: WuLucky Light Electronics Co., Ltd.

ang http://www.luckylightled.com

Drawn: Wang



Reliability Test Item And Condition:

The reliability of products shall be satisfied with items listed below:

Confidence level: 90%.

LTPD: 10%.

No.	Item	Test Conditions	Test Hours/ Cycles	Sample Sizes	Failure Judgment Criteria	Ac/ Re
1	Reflow Soldering	TEMP.: 260 <u>+</u> 5 5secs	6mins	22pcs		0/1
2	Temperature Cycle	H: +100 15mins 5 mins L: -40 15mins	50Cycles	22pcs		0/1
3	Thermal Shock	H: +100 15mins 10secs L: -10 5mins	50Cycles	22pcs	Ic _(ON) L×0 .8 L: Lower	0/1
4	High Temperature Storage	TEMP.: +100	1000hrs	22pcs	Specificatio n Limit	0/1
5	Lower Temperature Storage	TEMP.: -40	1000hrs	22pcs		0/1
6	DC Operating Life	$V_{CE}=5V$	1000hrs	22pcs		0/1
7	High Temperature/ High Humidity	85 / 85% R.H	1000hrs	22pcs		0/1



Please read the following notes before using the product:

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Storage
 - 2.1 Do not open moisture proof bag before the products are ready to use.
 - 2.2 Before opening the package, the LEDs should be kept at 30 or less and 80%RH or less.
 - 2.3 The LEDs should be used within a year.
 - 2.4 After opening the package, the LEDs should be kept at 30 or less and 60%RH or less.
 - 2.5 The LEDs should be used within 168 hours (7 days) after opening the package.
- 3. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 260 for 5 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

4. Soldering

When soldering, for Lamp without stopper type and must be leave a minimum of 3mm clearance from the base of the lens to the soldering point.

To avoided the Epoxy climb up on lead frame and was impact to non-soldering problem, dipping the lens into the solder must be avoided.

Do not apply any external stress to the lead frame during soldering while the LED is at high temperature.

Recommended soldering conditions:

Soldering Iron		Wave Soldering		
Temperature Soldering Time	300 Max. 3 sec. Max. (one time only)	Pre-heat Pre-heat Time Solder Wave Soldering Time	100 Max. 60 sec. Max. 260 Max. 5 sec. Max.	

Note: Excessive soldering temperature and / or time might result in deformation of the LED lens or catastrophic failure of the LED.

5. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used. It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.

6. Caution in ESD

Static Electricity and surge damages the LED. It is recommended to use a wrist band or anti-electrostatic glove when handling the LED. All devices equipment and machinery must be properly grounded.